PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4396898

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
YI QI	05/03/2017
JIANWEI PENG	05/03/2017
HSIEN-CHING LO	05/03/2017
KWAN-YONG LIM	05/03/2017
HUI ZHAN	05/03/2017

RECEIVING PARTY DATA

Name:	GLOBALFOUNDRIES INC.
Street Address:	PO BOX 309
Internal Address:	UGLAND HOUSE
City:	GRAND CAYMAN
State/Country:	CAYMAN ISLANDS
Postal Code:	KY1-1104

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15585865

CORRESPONDENCE DATA

Fax Number: (713)434-6671

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 7134346677

Email: mpaul@amersoniplaw.com

Correspondent Name: J. MIKE AMERSON

Address Line 1: 2500 FONDREN ROAD, SUITE 220

Address Line 4: HOUSTON, TEXAS 77063

ATTORNEY DOCKET NUMBER:	2162.276900/IMLT412
NAME OF SUBMITTER:	J. MIKE AMERSON
SIGNATURE:	/J. Mike Amerson/
DATE SIGNED:	05/03/2017
	This document serves as an Oath/Declaration (37 CFR 1.63).

PATENT REEL: 042228 FRAME: 0720

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Total Attachments: 5 source=Declaration_and_Assignment#page1.tif source=Declaration_and_Assignment#page2.tif source=Declaration_and_Assignment#page3.tif source=Declaration_and_Assignment#page4.tif source=Declaration_and_Assignment#page5.tif

Title of Invention	METHODS OF FORMING EPI SEMICONDUCTOR MATERIAL ON A THINNED FIN IN THE SOURCE/DRAIN REGIONS OF A FINFET DEVICE	
	DECLARATION	
As the below	named inventor, I hereby declare that:	
This declarati	This declaration	
	United States application or PCT international application number filed on	
The above-id	entified application was made or authorized to be made by me.	
I believe that	I am the original inventor or an original joint inventor of a claimed invention in the application.	
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.		
I have reviewed and understand the contents of the application and am aware of the duty to disclose to the US Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR § 1.56.		
ASSIGNMENT		
For good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, I hereby sell, assign, transfer, to GLOBALFOUNDRIES Inc. having a business address of PO Box 309, Ugland House, Grand Cayman KY1-1104 its successors and assigns, absolutely and forever, my entire right, title and interest in and to the invention listed above, together with the Application, any and all Patents that may issue in the United States and/or any foreign countries, and any reissues, re-examinations, renewals, continuations, continuation-in-parts, divisionals or extensions thereof that may be issued or granted, and all right, title and interest to the inventions contained in said Patents and Applications, for the United States and all foreign countries, and all the rights and privileges relating thereto including but not limited to the priority rights arising from said Applications, the right to recover and take all such proceedings as may be necessary for the recovery of damages or otherwise in respect of past, present and future infringement, and the right to apply for, take and maintain patents on said inventions.		
If any portion of this Combined Declaration or Assignment is held unenforceable, then remaining portions hereof shall nevertheless remain in full force and effect.		
	ME OF INVENTOR YI QI Date: 20/7/05/02	
Inventor:	YI QI Date: $\frac{2017/05/03}{}$	
Signature:		
	ication data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form.	

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LEGAL NAME OF INVENTOR		
Inventor:	Inventor: JIANWEI PENG Date: 05/03/20/7	
Signature:		
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LEGAL NA	ME OF INVENTOR
Inventor:	HSIEN-CHING LO Date: 05/03/2019
Signature	- Como A or
Note: An app Use an addition	lication data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. nal form for each additional inventor.

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LEGAL NAME OF INVENTOR	
Inventor:	KWAN-YONG LIM Date: May 3, 2017
Signature	Serry
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LEGAL NAME OF INVENTOR	
Inventor:	HUI ZHAN Date: 5/3/2017
Signature Signature	Min
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PATENT REEL: 042228 FRAME: 0726

RECORDED: 05/03/2017